2SB1416

Silicon PNP epitaxial planar type

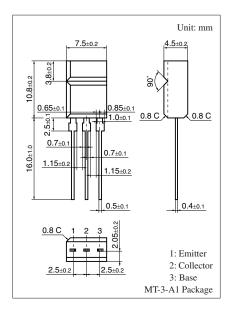
For low-frequency power amplification Complementary to 2SD2136

■ Features

- \bullet High forward current transfer ratio h_{FE} which has satisfactory linearity
- Low collector-emitter saturation voltage V_{CE(sat)}
- Allowing automatic insertion with radial taping

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V _{CBO}	-60	V
Collector-emitter voltage (Base open)	V _{CEO}	-60	V
Emitter-base voltage (Collector open)	V_{EBO}	-5	V
Collector current	I_C	-3	A
Peak collector current	I_{CP}	-5	A
Collector power dissipation	P _C	1.5	W
Junction temperature	T_j	150	°C
Storage temperature	T _{stg}	-55 to +150	°C



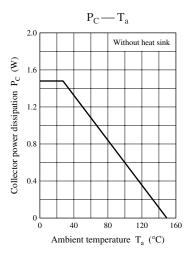
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

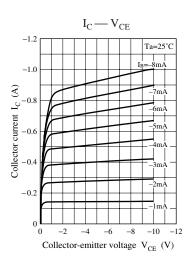
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_C = -30 \text{ mA}, I_B = 0$	-60			V
Base-emitter voltage	V_{BE}	$V_{CE} = -4 \text{ V}, I_{C} = -3 \text{ A}$			-1.8	V
Collector-emitter cutoff current (E-B short)	I _{CES}	$V_{CE} = -60 \text{ V}, V_{BE} = 0$			-200	μΑ
Collector-emitter cutoff current (Base open)	I_{CEO}	$V_{CE} = -30 \text{ V}, I_{B} = 0$			-300	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = -5 \text{ V}, I_{C} = 0$			-1	mA
Forward current transfer ratio	h _{FE1} *	$V_{CE} = -4 \text{ V}, I_{C} = -1 \text{ A}$	40		250	_
	h _{FE2}	$V_{CE} = -4 \text{ V}, I_{C} = -3 \text{ A}$	10			
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = -3 A, I_B = -0.375A$			-1.2	V
Transition frequency	f_T	$V_{CB} = -5 \text{ V}, I_E = 0.1 \text{ A}, f = 200 \text{ MHz}$		270		MHz
Turn-on time	t _{on}	$I_C = -1 A, I_{B1} = -0.1 A, I_{B2} = 0.1 A$		0.5		μs
Storage time	t _{stg}			1.2		μs
Fall time	$t_{\rm f}$			0.3		μs

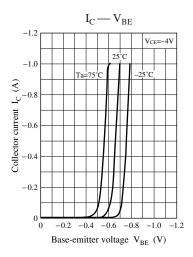
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

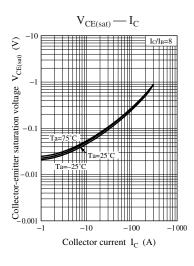
2. *: Rank classification

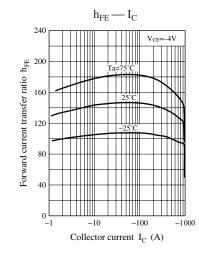
Rank	Р	Q	R
$h_{\rm FE1}$	40 to 90	70 to 150	120 to 250

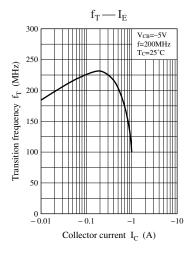


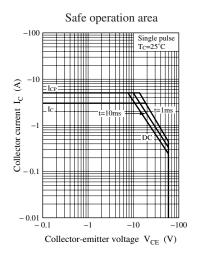




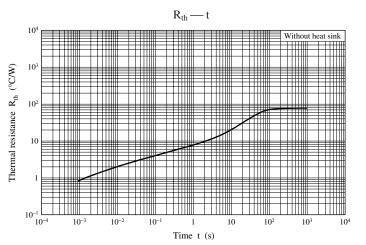








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